

Final datasheet

EconoDUAL™3 module with fast Trench/Fieldstop IGBT4 and emitter controlled diode and NTC

Features

- Electrical features
 - $V_{CES} = 650\text{ V}$
 - $I_{C\text{ nom}} = 450\text{ A} / I_{CRM} = 900\text{ A}$
 - Trench IGBT 4
 - $T_{vj,op} = 150^{\circ}\text{C}$
 - Increased DC-link voltage
 - High short-circuit capability
 - High current density
 - Increased blocking voltage capability up to 650 V
 - High surge current capability
 - Suitable Infineon gate drivers can be found under <https://www.infineon.com/gdfinder>
- Mechanical features
 - Copper base plate
 - High power density
 - Integrated NTC temperature sensor
 - Isolated base plate
 - Standard housing
 - Solder contact technology



Potential applications

- Commercial agriculture vehicles
- UPS systems
- Solar applications
- Motor drives

Product validation

- Qualified for industrial applications according to the relevant tests of IEC 60747, 60749 and 60068

Description

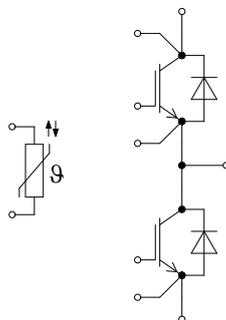


Table of contents

	Description	1
	Features	1
	Potential applications	1
	Product validation	1
	Table of contents	2
1	Package	3
2	IGBT, Inverter	4
3	Diode, Inverter	5
4	NTC-Thermistor	6
5	Characteristics diagrams	7
6	Circuit diagram	10
7	Package outlines	11
8	Module label code	12
	Revision history	13
	Disclaimer	14

1 Package

Table 1 Insulation coordination

Parameter	Symbol	Note or test condition	Values	Unit
Isolation test voltage	V_{ISOL}	RMS, $f = 50$ Hz, $t = 1$ min	2.5	kV
Isolation test voltage NTC	$V_{ISOL(NTC)}$	RMS, $f = 50$ Hz, $t = 1$ min	2.5	kV
Material of module baseplate			Cu	
Internal isolation		basic insulation (class 1, IEC 61140)	Al_2O_3	
Creepage distance	$d_{Creep\ nom}$	terminal to baseplate, nom.	> 15	mm
Creepage distance	$d_{Creep\ min}$	terminal to baseplate, min.	14.7	mm
Creepage distance	$d_{Creep\ nom}$	terminal to terminal, nom.	> 19.3	mm
Creepage distance	$d_{Creep\ min}$	terminal to terminal, min.	19.3	mm
Clearance	$d_{Clear\ nom}$	terminal to baseplate, nom.	> 12.5	mm
Clearance	$d_{Clear\ min}$	terminal to baseplate, min.	12.5	mm
Clearance	$d_{Clear\ nom}$	terminal to terminal, nom.	> 10	mm
Clearance	$d_{Clear\ min}$	terminal to terminal, min.	9.6	mm
Comparative tracking index	CTI		> 200	
Relative thermal index (electrical)	RTI	housing	140	°C

Table 2 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit	
			Min.	Typ.	Max.		
Stray inductance module	L_{sCE}			20		nH	
Module lead resistance, terminals - chip	$R_{CC'+EE'}$	$T_C = 25$ °C, per switch		1.1		mΩ	
Storage temperature	T_{stg}		-40		125	°C	
Mounting torque for module mounting	M	- Mounting according to valid application note	M5, Screw	3		6	Nm
Terminal connection torque	M	- Mounting according to valid application note	M6, Screw	3		6	Nm
Weight	G			345		g	

2 IGBT, Inverter

Table 3 Maximum rated values

Parameter	Symbol	Note or test condition	Values	Unit
Collector-emitter voltage	V_{CES}	$T_{vj} = 25\text{ °C}$	650	V
Continuous DC collector current	I_{CDC}	$T_{vj\text{ max}} = 175\text{ °C}$ $T_C = 70\text{ °C}$	450	A
Repetitive peak collector current	I_{CRM}	t_p limited by $T_{vj\text{ op}}$	900	A
Gate-emitter peak voltage	V_{GES}		± 20	V

Table 4 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Collector-emitter saturation voltage	$V_{CE\text{ sat}}$	$I_C = 450\text{ A}, V_{GE} = 15\text{ V}$	$T_{vj} = 25\text{ °C}$	1.55	1.95	V
			$T_{vj} = 125\text{ °C}$	1.70		
			$T_{vj} = 150\text{ °C}$	1.75		
Gate threshold voltage	V_{GETh}	$I_C = 7.2\text{ mA}, V_{CE} = V_{GE}, T_{vj} = 25\text{ °C}$	5.10	5.80	6.40	V
Gate charge	Q_G	$V_{GE} = \pm 15\text{ V}, T_{vj} = 25\text{ °C}$		4.8		μC
Internal gate resistor	R_{Gint}	$T_{vj} = 25\text{ °C}$		0.67		Ω
Input capacitance	C_{ies}	$f = 1000\text{ kHz}, T_{vj} = 25\text{ °C}, V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}$		27.5		nF
Reverse transfer capacitance	C_{res}	$f = 1000\text{ kHz}, T_{vj} = 25\text{ °C}, V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}$		0.82		nF
Collector-emitter cut-off current	I_{CES}	$V_{CE} = 650\text{ V}, V_{GE} = 0\text{ V}$ $T_{vj} = 25\text{ °C}$			1	mA
Gate-emitter leakage current	I_{GES}	$V_{CE} = 0\text{ V}, V_{GE} = 20\text{ V}, T_{vj} = 25\text{ °C}$			100	nA
Turn-on delay time (inductive load)	t_{don}	$I_C = 450\text{ A}, V_{CC} = 300\text{ V}, V_{GE} = \pm 15\text{ V}, R_{Gon} = 1.8\text{ }\Omega$	$T_{vj} = 25\text{ °C}$	0.085		μs
			$T_{vj} = 125\text{ °C}$	0.089		
			$T_{vj} = 150\text{ °C}$	0.093		
Rise time (inductive load)	t_r	$I_C = 450\text{ A}, V_{CC} = 300\text{ V}, V_{GE} = \pm 15\text{ V}, R_{Gon} = 1.8\text{ }\Omega$	$T_{vj} = 25\text{ °C}$	0.082		μs
			$T_{vj} = 125\text{ °C}$	0.087		
			$T_{vj} = 150\text{ °C}$	0.088		
Turn-off delay time (inductive load)	t_{doff}	$I_C = 450\text{ A}, V_{CC} = 300\text{ V}, V_{GE} = \pm 15\text{ V}, R_{Goff} = 1.8\text{ }\Omega$	$T_{vj} = 25\text{ °C}$	0.480		μs
			$T_{vj} = 125\text{ °C}$	0.510		
			$T_{vj} = 150\text{ °C}$	0.520		

(table continues...)

Table 4 (continued) **Characteristic values**

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Fall time (inductive load)	t_f	$I_C = 450 \text{ A}, V_{CC} = 300 \text{ V}, V_{GE} = \pm 15 \text{ V}, R_{Goff} = 1.8 \Omega$	$T_{vj} = 25 \text{ }^\circ\text{C}$		0.067	μs
			$T_{vj} = 125 \text{ }^\circ\text{C}$		0.093	
			$T_{vj} = 150 \text{ }^\circ\text{C}$		0.099	
Turn-on energy loss per pulse	E_{on}	$I_C = 450 \text{ A}, V_{CC} = 300 \text{ V}, L_\sigma = 30 \text{ nH}, V_{GE} = \pm 15 \text{ V}, R_{Gon} = 1.8 \Omega, di/dt = 4900 \text{ A}/\mu\text{s} (T_{vj} = 150 \text{ }^\circ\text{C})$	$T_{vj} = 25 \text{ }^\circ\text{C}$		3.4	mJ
			$T_{vj} = 125 \text{ }^\circ\text{C}$		4.6	
			$T_{vj} = 150 \text{ }^\circ\text{C}$		4.9	
Turn-off energy loss per pulse	E_{off}	$I_C = 450 \text{ A}, V_{CC} = 300 \text{ V}, L_\sigma = 30 \text{ nH}, V_{GE} = \pm 15 \text{ V}, R_{Goff} = 1.8 \Omega, dv/dt = 2600 \text{ V}/\mu\text{s} (T_{vj} = 150 \text{ }^\circ\text{C})$	$T_{vj} = 25 \text{ }^\circ\text{C}$		23.5	mJ
			$T_{vj} = 125 \text{ }^\circ\text{C}$		28.5	
			$T_{vj} = 150 \text{ }^\circ\text{C}$		30	
SC data	I_{SC}	$V_{GE} \leq 15 \text{ V}, V_{CC} = 360 \text{ V}, V_{CEmax} = V_{CES} - L_{SCE} \cdot di/dt$	$t_p \leq 10 \mu\text{s}, T_{vj} = 150 \text{ }^\circ\text{C}$		2400	A
Thermal resistance, junction to case	R_{thJC}	per IGBT			0.102	K/W
Thermal resistance, case to heat sink	R_{thCH}	per IGBT, $\lambda_{grease} = 1 \text{ W}/(\text{m}\cdot\text{K})$			0.039	K/W
Temperature under switching conditions	$T_{vj op}$			-40	150	$^\circ\text{C}$

3 Diode, Inverter

Table 5 **Maximum rated values**

Parameter	Symbol	Note or test condition	Values	Unit	
Repetitive peak reverse voltage	V_{RRM}	$T_{vj} = 25 \text{ }^\circ\text{C}$	650	V	
Continuous DC forward current	I_F		450	A	
Repetitive peak forward current	I_{FRM}	$t_p = 1 \text{ ms}$	900	A	
I^2t - value	I^2t	$t_p = 10 \text{ ms}, V_R = 0 \text{ V}$	$T_{vj} = 125 \text{ }^\circ\text{C}$	15000	A^2s
			$T_{vj} = 150 \text{ }^\circ\text{C}$	14500	

Table 6 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit	
			Min.	Typ.	Max.		
Forward voltage	V_F	$I_F = 450 \text{ A}, V_{GE} = 0 \text{ V}$	$T_{vj} = 25 \text{ °C}$		1.55	1.95	V
			$T_{vj} = 125 \text{ °C}$		1.50		
			$T_{vj} = 150 \text{ °C}$		1.45		
Peak reverse recovery current	I_{RM}	$V_{CC} = 300 \text{ V}, I_F = 450 \text{ A}, V_{GE} = -15 \text{ V}, -di_F/dt = 4900 \text{ A}/\mu\text{s} (T_{vj} = 150 \text{ °C})$	$T_{vj} = 25 \text{ °C}$		185		A
			$T_{vj} = 125 \text{ °C}$		270		
			$T_{vj} = 150 \text{ °C}$		285		
Recovered charge	Q_r	$V_{CC} = 300 \text{ V}, I_F = 450 \text{ A}, V_{GE} = -15 \text{ V}, -di_F/dt = 4900 \text{ A}/\mu\text{s} (T_{vj} = 150 \text{ °C})$	$T_{vj} = 25 \text{ °C}$		26.5		μC
			$T_{vj} = 125 \text{ °C}$		30		
			$T_{vj} = 150 \text{ °C}$		35.5		
Reverse recovery energy	E_{rec}	$V_{CC} = 300 \text{ V}, I_F = 450 \text{ A}, V_{GE} = -15 \text{ V}, -di_F/dt = 4900 \text{ A}/\mu\text{s} (T_{vj} = 150 \text{ °C})$	$T_{vj} = 25 \text{ °C}$		5.9		mJ
			$T_{vj} = 125 \text{ °C}$		8.9		
			$T_{vj} = 150 \text{ °C}$		10.5		
Thermal resistance, junction to case	R_{thJC}	per diode			0.165	K/W	
Thermal resistance, case to heat sink	R_{thCH}	per diode, $\lambda_{grease} = 1 \text{ W}/(\text{m}\cdot\text{K})$		0.04		K/W	
Temperature under switching conditions	$T_{vj op}$		-40		150	°C	

4 NTC-Thermistor

Table 7 Characteristic values

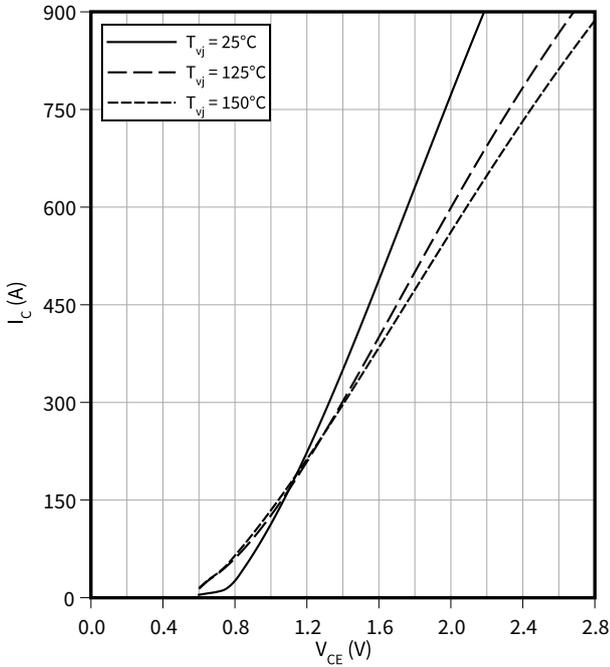
Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Rated resistance	R_{25}	$T_{NTC} = 25 \text{ °C}$		5		k Ω
Deviation of R_{100}	$\Delta R/R$	$T_{NTC} = 100 \text{ °C}, R_{100} = 493 \text{ }\Omega$	-5		5	%
Power dissipation	P_{25}	$T_{NTC} = 25 \text{ °C}$			20	mW
B-value	$B_{25/50}$	$R_2 = R_{25} \exp[B_{25/50}(1/T_2 - 1/(298,15 \text{ K}))]$		3375		K
B-value	$B_{25/80}$	$R_2 = R_{25} \exp[B_{25/80}(1/T_2 - 1/(298,15 \text{ K}))]$		3411		K
B-value	$B_{25/100}$	$R_2 = R_{25} \exp[B_{25/100}(1/T_2 - 1/(298,15 \text{ K}))]$		3433		K

Note: For an analytical description of the NTC characteristics please refer to AN2009-10, chapter 4

5 Characteristics diagrams

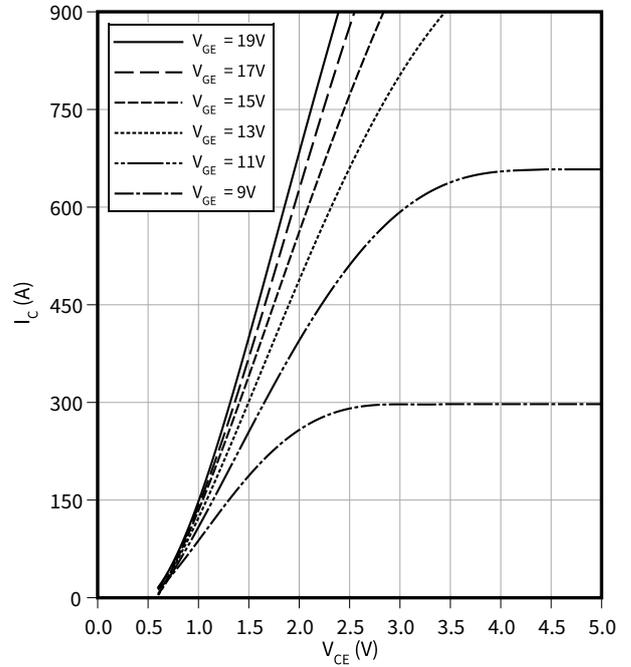
Output characteristic (typical), IGBT, Inverter

$I_C = f(V_{CE})$
 $V_{GE} = 15\text{ V}$



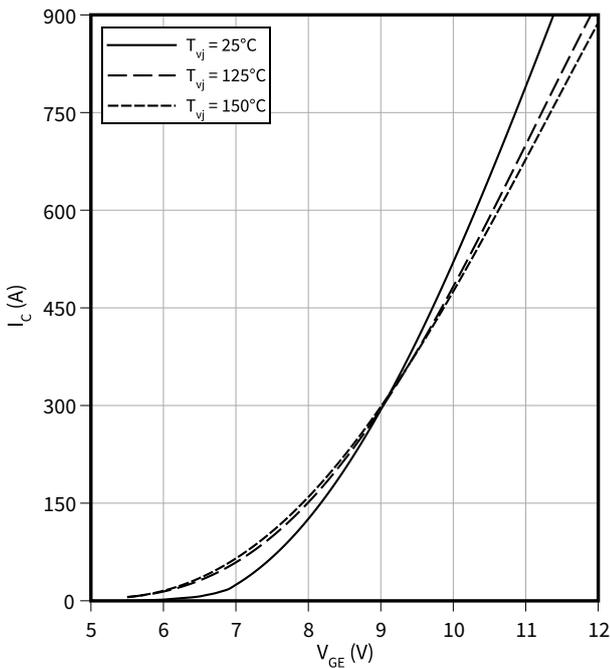
Output characteristic field (typical), IGBT, Inverter

$I_C = f(V_{CE})$
 $T_{vj} = 150\text{ °C}$



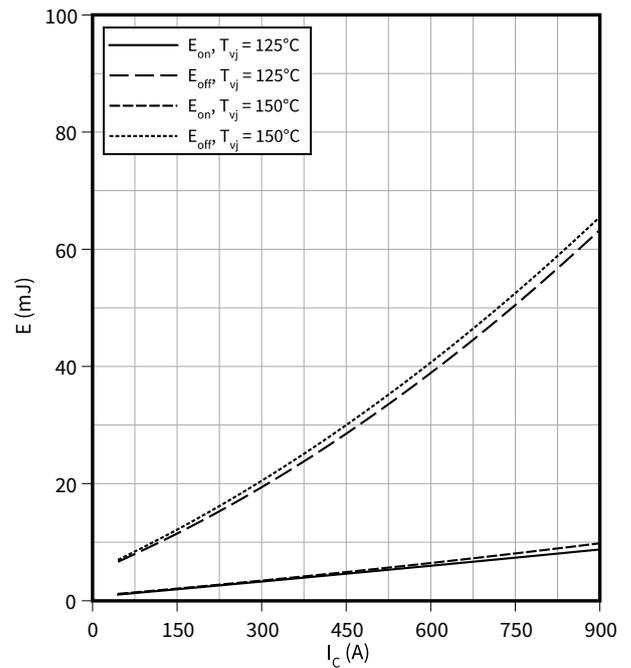
Transfer characteristic (typical), IGBT, Inverter

$I_C = f(V_{GE})$
 $V_{CE} = 20\text{ V}$



Switching losses (typical), IGBT, Inverter

$E = f(I_C)$
 $R_{Goff} = 1.8\ \Omega, R_{Gon} = 1.8\ \Omega, V_{GE} = \pm 15\text{ V}, V_{CC} = 300\text{ V}$

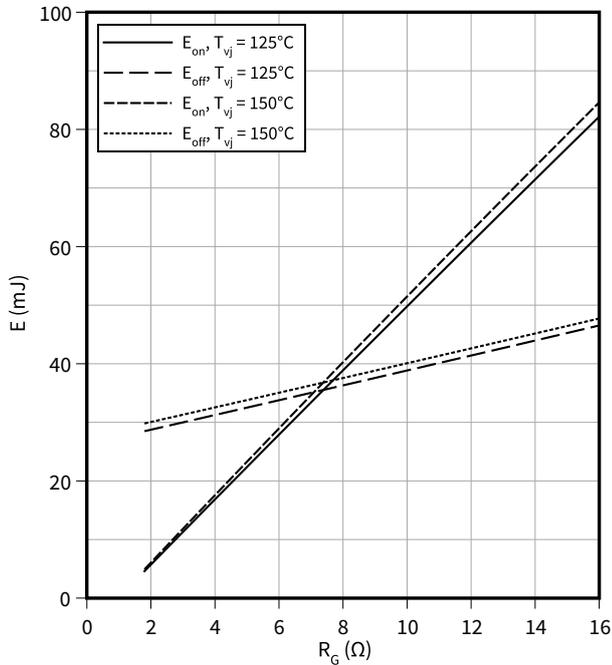


5 Characteristics diagrams

Switching losses (typical), IGBT, Inverter

$E = f(R_G)$

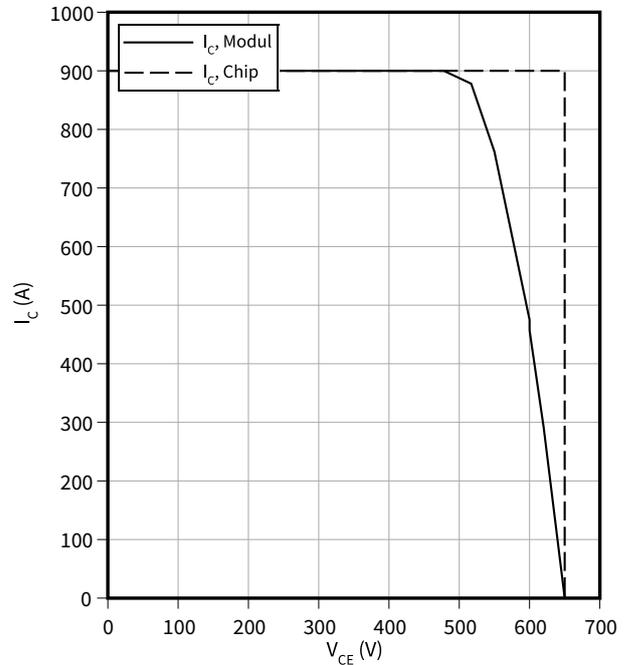
$V_{GE} = \pm 15\text{ V}$, $I_C = 450\text{ A}$, $V_{CC} = 300\text{ V}$



Reverse bias safe operating area (RBSOA), IGBT, Inverter

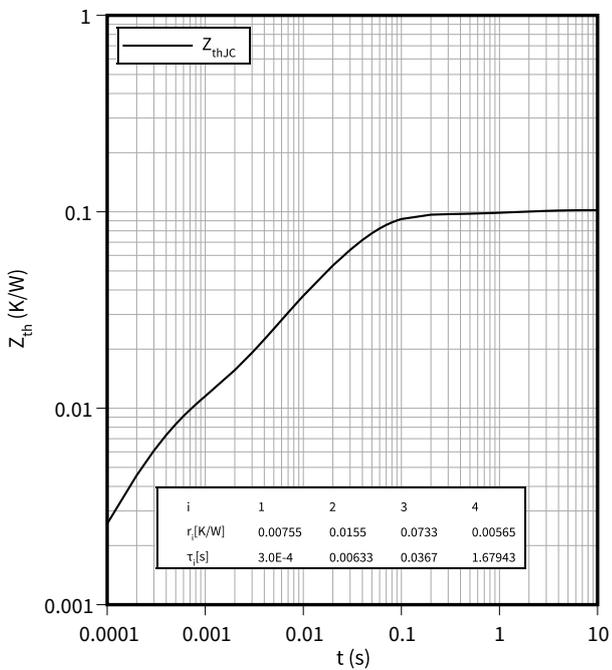
$I_C = f(V_{CE})$

$R_{Goff} = 1.8\ \Omega$, $V_{GE} = \pm 15\text{ V}$, $T_{vj} = 150\text{ °C}$



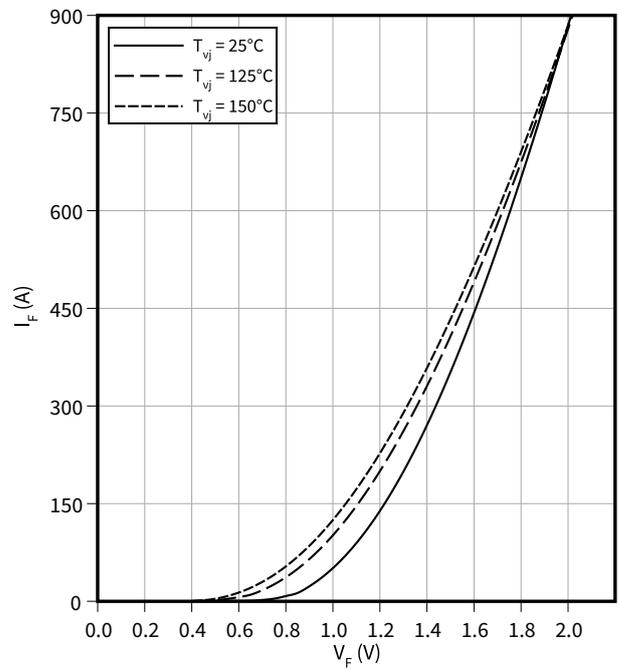
Transient thermal impedance, IGBT, Inverter

$Z_{th} = f(t)$



Forward characteristic (typical), Diode, Inverter

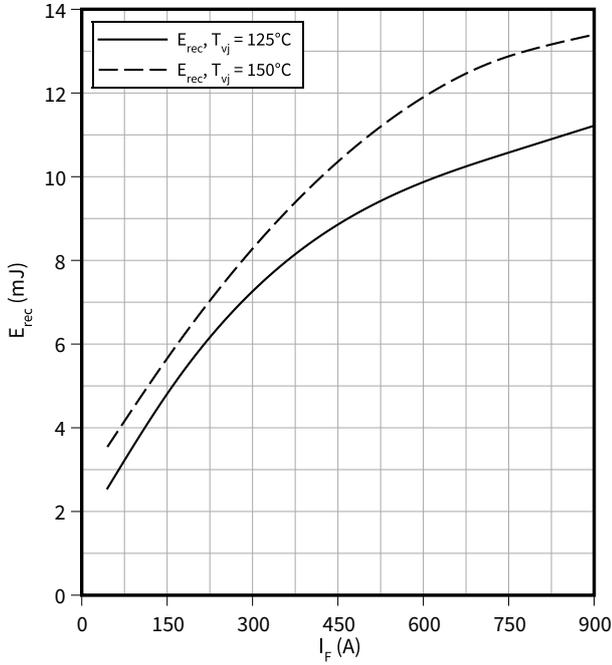
$I_F = f(V_F)$



5 Characteristics diagrams

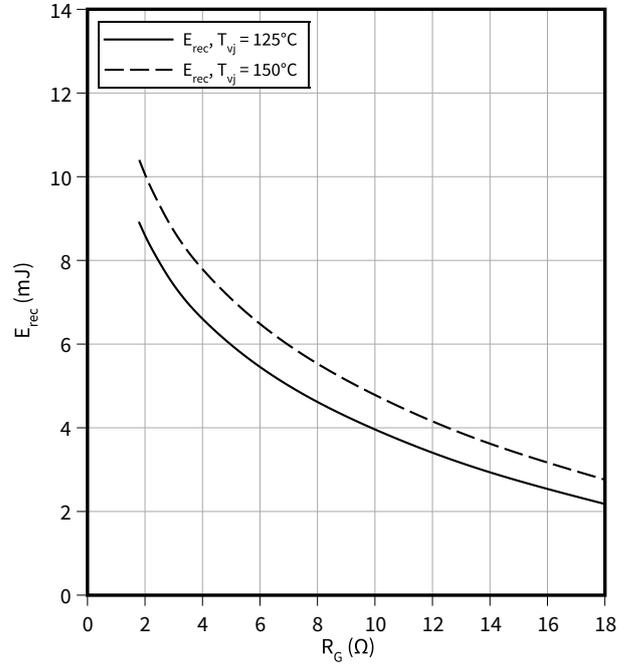
Switching losses (typical), Diode, Inverter

$E_{rec} = f(I_F)$
 $R_{Gon} = 1.8 \Omega, V_{CE} = 300 V$



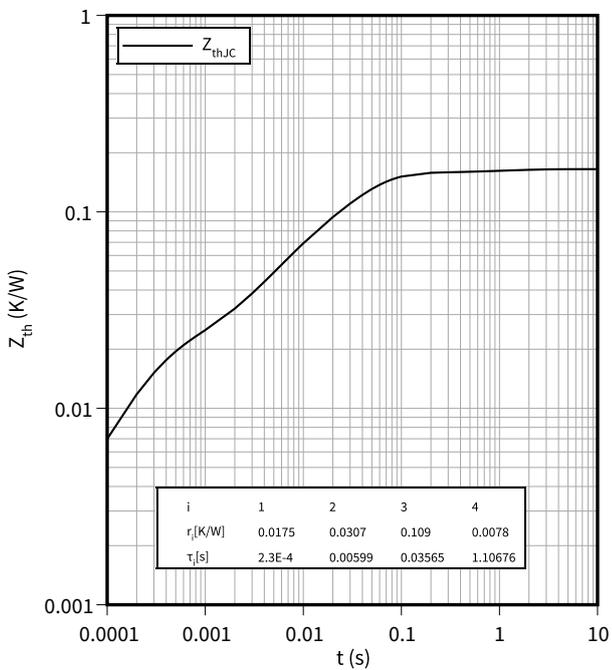
Switching losses (typical), Diode, Inverter

$E_{rec} = f(R_G)$
 $V_{CE} = 300 V, I_F = 450 A$



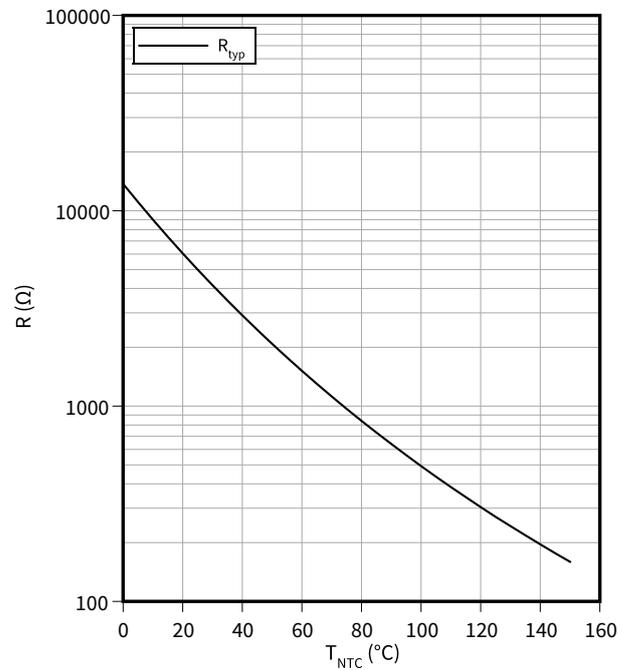
Transient thermal impedance, Diode, Inverter

$Z_{th} = f(t)$



Temperature characteristic (typical), NTC-Thermistor

$R = f(T_{NTC})$



6 Circuit diagram

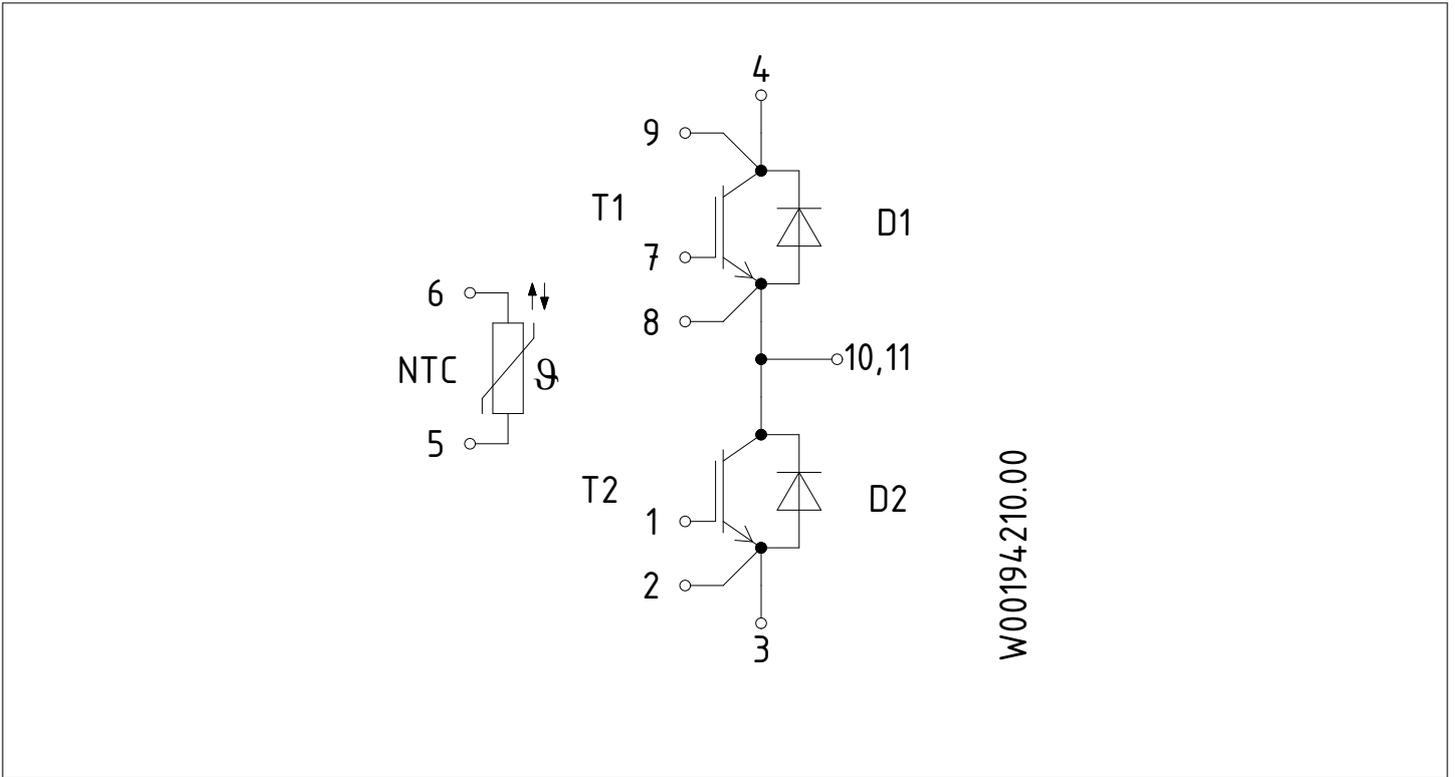


Figure 1

8 Module label code

Module label code			
Code format	Data Matrix	Barcode Code128	
Encoding	ASCII text	Code Set A	
Symbol size	16x16	23 digits	
Standard	IEC24720 and IEC16022	IEC8859-1	
Code content	<i>Content</i>	<i>Digit</i>	<i>Example</i>
	Module serial number	1 - 5	71549
	Module material number	6 - 11	142846
	Production order number	12 - 19	55054991
	Date code (production year)	20 - 21	15
	Date code (production week)	22 - 23	30
Example	 		
	71549142846550549911530		71549142846550549911530

Figure 3

Revision history

Document revision	Date of release	Description of changes
V1.0	2010-09-15	Target datasheet
V1.1	2011-03-01	Target datasheet
V1.2	2011-03-25	Target datasheet
V3.0	2019-08-27	Final datasheet
n/a	2020-09-01	Datasheet migrated to a new system with a new layout and new revision number schema: target or preliminary datasheet = 0.xy; final datasheet = 1.xy
1.10	2025-09-02	Final datasheet

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